1 Description

The CN91C4S48 is a segment-type LCD driver chip with a duty cycle of 1/4, capable of driving up to 192 segments. This device incorporates a low-power design, enabling it to achieve ultra-low power consumption and reduce power loss from the power supply.

2 Features

- Fixed 1/4 duty mode, Up to 192 dots
- Low power consumption design, 6uA current at typical condition
- Built-in OSC Circuit
- Internal LCD Contrast control Circuit
- Integrated Power-on Reset Circuit
- No external component required
- Interface: 2 line serial I2C
- Compatible with TTL/CMOS
- High EMC immunity

3 Applications

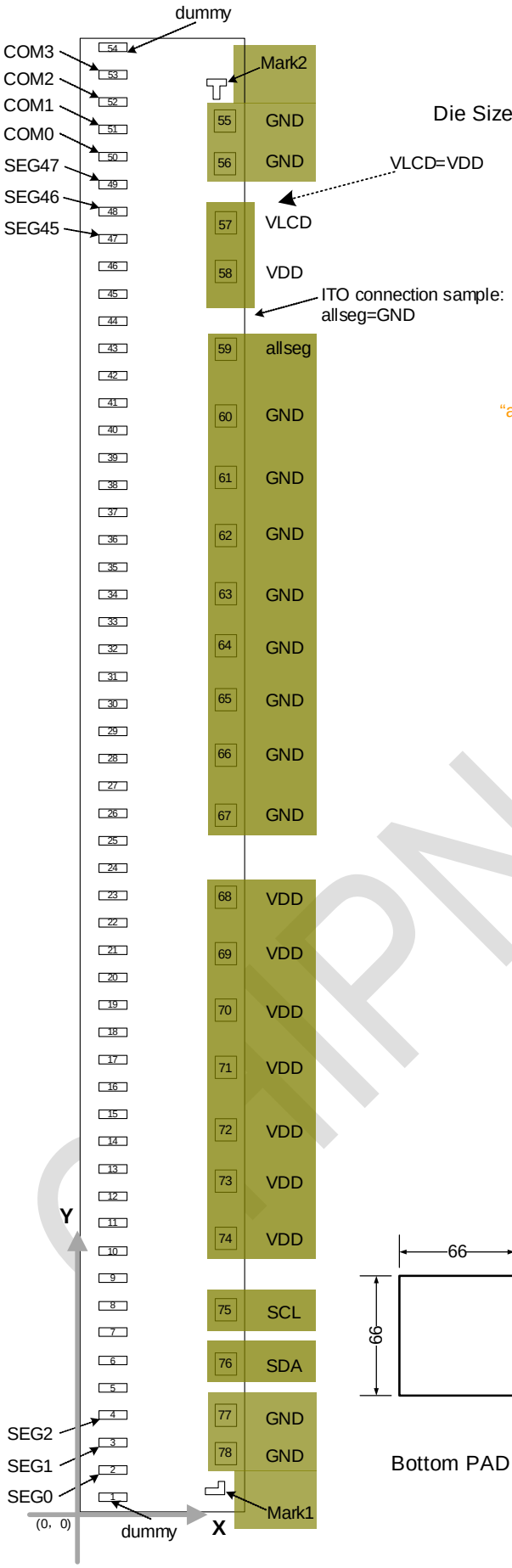
- Home electrical appliance
- Meter equipment etc.
- Toys
- PDA
- Clocks

4 Order Information

Product Number	Package	Quantity
CN91C4S48	COG	154/Tray

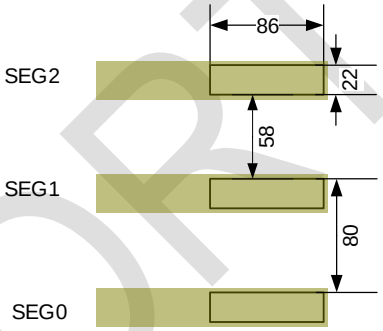
5 PAD Description

Name	I/O	Function
SDA	I/O	2-line serial I2C, data input and output
SCL	I	Open-Drain, and a pull-up resistor on board is needed.
VSS	I	GND
VDD	I	Power
VLCD	I	Set LCD bias voltage. It can be directly tied to VDD, and then you can adjust the internal LCD bias voltage by setting the register EV[3:0]. The voltage applied to VLCD pin must be equal to or lower than VDD.
allseg	I	Should be directly tied to GND
SEG0~SEG47	O	SEGMENT driver output for LCD
COM0~COM3	O	COMMON driver output for LCD



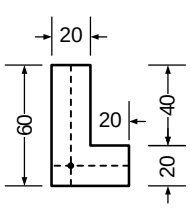
Die Thickness:	300um
Die Size(without scribe lane):	4300um X 500um
Bump Hight:	9um ± 2um
SEG Bump Width:	22um
SEG Bump Space:	58um
SEG Bump Pitch:	80um

"allseg" PAD is very important, it defines the SEG ITO pitch.
Please refer to the SEG ITO samples as follows:

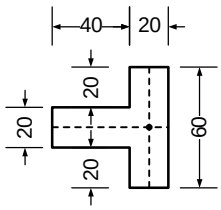


(allseg=GND)

Bottom PAD



Mark 1



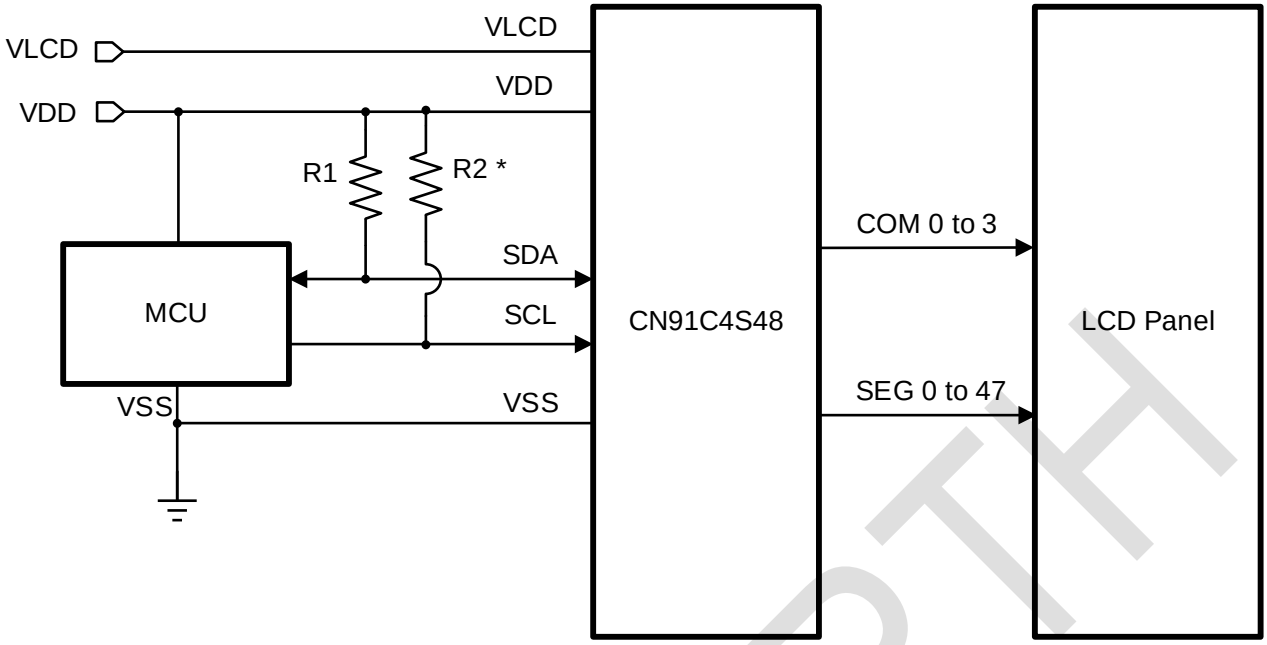
Mark 2

6 PAD Coordinates for COG

UNIT： μm

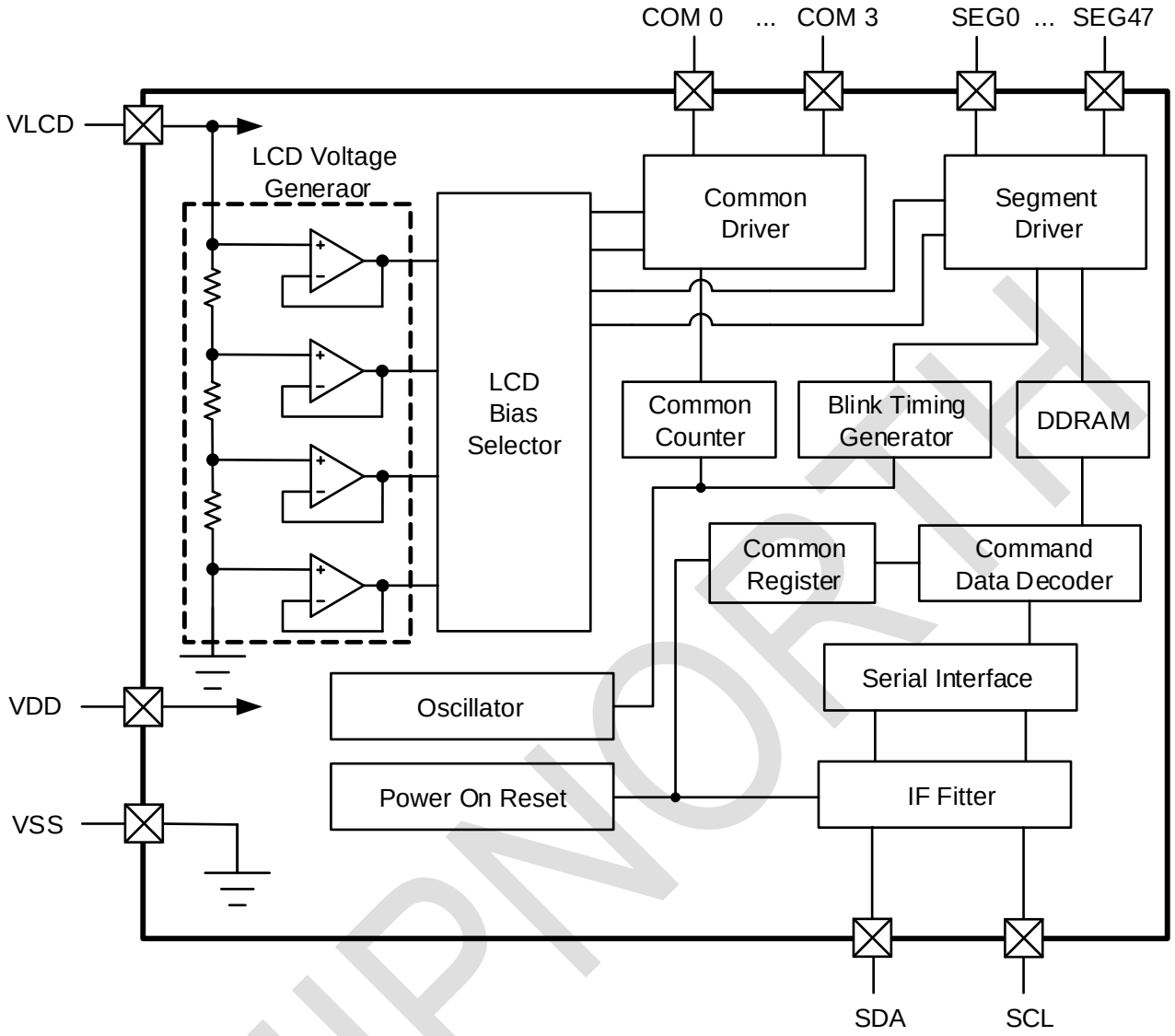
No	Name	X	Y	No	Name	X	Y
1	dummy	110	30	40	SEG38	110	3150
2	SEG0	110	110	41	SEG39	110	3230
3	SEG1	110	190	42	SEG40	110	3310
4	SEG2	110	270	43	SEG41	110	3390
5	SEG3	110	350	44	SEG42	110	3470
6	SEG4	110	430	45	SEG43	110	3550
7	SEG5	110	510	46	SEG44	110	3630
8	SEG6	110	590	47	SEG45	110	3710
9	SEG7	110	670	48	SEG46	110	3790
10	SEG8	110	750	49	SEG47	110	3870
11	SEG9	110	830	50	COM0	110	3950
12	SEG10	110	910	51	COM1	110	4030
13	SEG11	110	990	52	COM2	110	4110
14	SEG12	110	1070	53	COM3	110	4190
15	SEG13	110	1150	54	dummy	110	4270
16	SEG14	110	1230	55	GND	444	4140
17	SEG15	110	1310	56	GND	444	4020
18	SEG16	110	1390	57	VLCD	444	3797
19	SEG17	110	1470	58	VDD	444	3637
20	SEG18	110	1550	59	allseg	444	3435
21	SEG19	110	1630	60	GND	444	3224
22	SEG20	110	1710	61	GND	444	3064
23	SEG21	110	1790	62	GND	444	2904
24	SEG22	110	1870	63	GND	444	2744
25	SEG23	110	1950	64	GND	444	2584
26	SEG24	110	2030	65	GND	444	2424
27	SEG25	110	2110	66	GND	444	2264
28	SEG26	110	2190	67	GND	444	2104
29	SEG27	110	2270	68	VDD	444	1860
30	SEG28	110	2350	69	VDD	444	1700
31	SEG29	110	2430	70	VDD	444	1540
32	SEG30	110	2510	71	VDD	444	1380
33	SEG31	110	2590	72	VDD	444	1220
34	SEG32	110	2670	73	VDD	444	1060
35	SEG33	110	2750	74	VDD	444	900
36	SEG34	110	2830	75	SCL	444	670
37	SEG35	110	2910	76	SDA	444	490
38	SEG36	110	2990	77	GND	444	280
39	SEG37	110	3070	78	GND	444	160
	Mark1	434	54		Mark2	414	4246

7 Typical Application



Note: * R2 is optional.

8 Block Diagram



9 Specifications

9.1 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit	Remarks
Power Supply Voltage	V_{DD}	-0.3 to +6.5	V	Power supply
Power Supply Voltage 1	V_{LCD}	-0.3 to +V_{DD}	V	LCD drive voltage
Input voltage range	V_{IN}	-0.3 to V_{DD}+0.3	V	
Soldering Temperature	T_{lead}	260（soldering，10s）	°C	
Operational temperature range	T_{opr}	-40 to 105	°C	
Storage temperature range	T_{stg}	-55 to 150	°C	

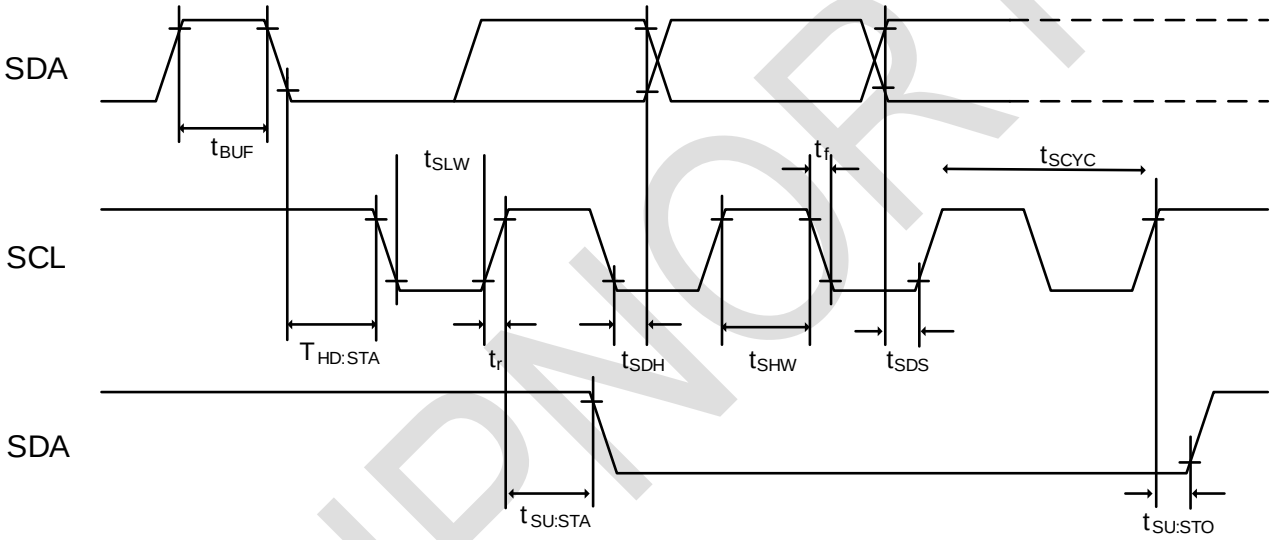
9.2 Electrical Characteristics

Test conditions: VDD=3.3V, TA = 25 °C unless otherwise noted.

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
VDD Power Range	V_{DD}		2.7	-	5.5	V
VLCD Power Range	V_{LCD}	LCD drive voltage	2.7	-	V_{DD}	V
“H” Level Input Voltage	V_{IH}		0.8V_{DD}	-	V_{DD}	V
“L” Level Input Voltage	V_{IL}		V_{SS}	-	0.2V_{DD}	V
SDA "L" Level Output Voltage	V_{OL_sda}	I_{Load}=-3mA Without the consideration of ITO resistance on COG panel.	0	-	0.4	V
COM/SEG ON Resistance	R_{ON}	I_{Load}=±10uA	-	3	-	kΩ
Frame Frequency	F_{clk}	FR=72Hz setting	-	72	-	Hz
Standby Current	I_{DD1}	Display off, Oscillation off	-	-	1	uA
Operating Current	I_{DD2}	VDD=3.3V, Ta=25℃, SR=Power save mode 1, Frame inversion, FR=72Hz.	-	6	20	uA

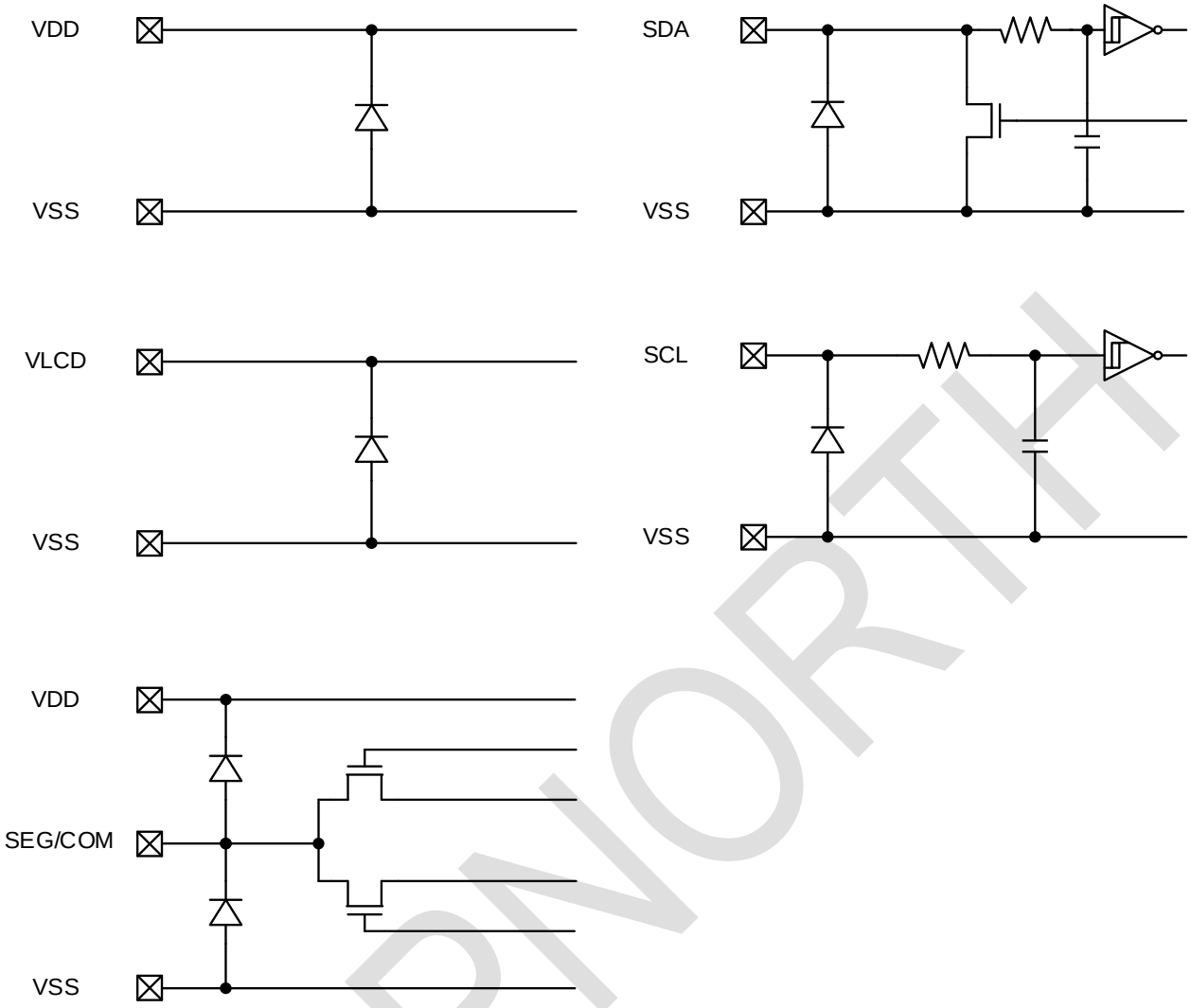
9.3 MPU Interface Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input Rise Time	t_r		-	-	1000	ns
Input Fall Time	t_f		-	-	300	ns
SCL Cycle Time	t_{SCYC}		10	-	-	us
“H” Level SCL Pulse Width	t_{SHW}		4	-	-	us
“L” Level SCL Pulse Width	t_{SLW}		4.7	-	-	us
SDA Setup Time	t_{SDS}		250	-	-	ns
SDA Hold Time	t_{SDH}		250	-	-	ns
Bus Free Time	t_{BUF}		4.7	-	-	us
START Condition Hold Time	$t_{HD;STA}$		4	-	-	us
START Condition Setup Time	$t_{SU;STA}$		4.7	-	-	us
STOP Condition Setup Time	$t_{SU;STO}$		4	-	-	us



2-line serial interface timing

10 Equivalent circuit of input and output



11 Command Registers Description

	7	6	5	4	3	2	1	0
ADSET	**C**	**0**	**0**	P[4:0]				
DISCTL	**C**	**0**	**1**	FR[1:0]		LF	SR[1:0]	
MODSET	**C**	**1**	**0**	ULP	EN	/	/	/
EVRSET	**C**	**1**	**1**	**0**	**0**	EV[2:0]		
ICSET	**C**	**1**	**1**	**0**	**1**	P[5]	RST	P[6]
BLKCTL	**C**	**1**	**1**	**1**	**0**	BF[2:0]		
APCTL	**C**	**1**	**1**	**1**	**1**	EV[3]	AON	AOFF

Name	Default	Description
P[6:0]	0000000	DDRAM Address. In the write mode, the range of address P [6:0] can be set as 0~2F(Hex). In the read mode, the range of address P [6:0] can be set as 0~2F, 30~32(Hex). Don't specify another address, otherwise address will be set to "0000000". Note: The P[5] and P[6] are in the command 'ICSET'.
FR[1:0]	00	Set Frame Frequency for Power Saving. 00, 72Hz, Normal Mode 01, 96Hz Operating Mode1 10, 49Hz, Operating Mode 2 11, 144Hz, Operating Mode 3
LF	0	Set Line or Frame inverse mode. 0, Line inverse 1, Frame inverse
SR[1:0]	10	Set internal bias current for Power Saving. 00, *0.5, Power Save Mode 1 01, *0.67, Power Save Mode 2 10, *1.0, Normal Mode, default value 11, *1.8, High Power Mode
ULP	0	Set '1' to enable the Ultra-Low-Power mode, which can decrease total power consumption further more along with 'SR' and 'FR' Power Save Mode.
EN	0	0: disable all blocks on-chip, all com/seg pin will be pulled to GND. 1: enable
EV[3:0]	0000	Adjust resistor divider for LCD contrast setting. 0000, 1.000 * VLCD 0001, 0.975 * VLCD 0010, 0.950 * VLCD 0011, 0.925 * VLCD 0100, 0.900 * VLCD 0101, 0.875 * VLCD 0110, 0.850 * VLCD 0111, 0.825 * VLCD 1000, 0.800 * VLCD 1001, 0.775 * VLCD 1010, 0.750 * VLCD 1011, 0.725 * VLCD 1100, 0.700 * VLCD 1101, 0.675 * VLCD 1110, 0.650 * VLCD 1111, 0.625 * VLCD Note: The bit EV[3] is in the command 'APCTL'.
RST	0	Set '1' to reset all the registers in this table, but it won't reset the display data in the DDRAM.
BF[2:0]	000	Config the blink frequency. 000, No blink.

		001, 0.3Hz 010, 0.25Hz 011, 2Hz 100~111, 1Hz
AON: AOFF	00	Config the pixel display. 00, All pixels are ON/OFF depending on the data in the display DDRAM. 01, All pixels are OFF regardless of DDRAM data. 10, All pixels are ON regardless of DDRAM data. 11, All pixels are OFF regardless of DDRAM data, the same as '01'.

12 Function Description

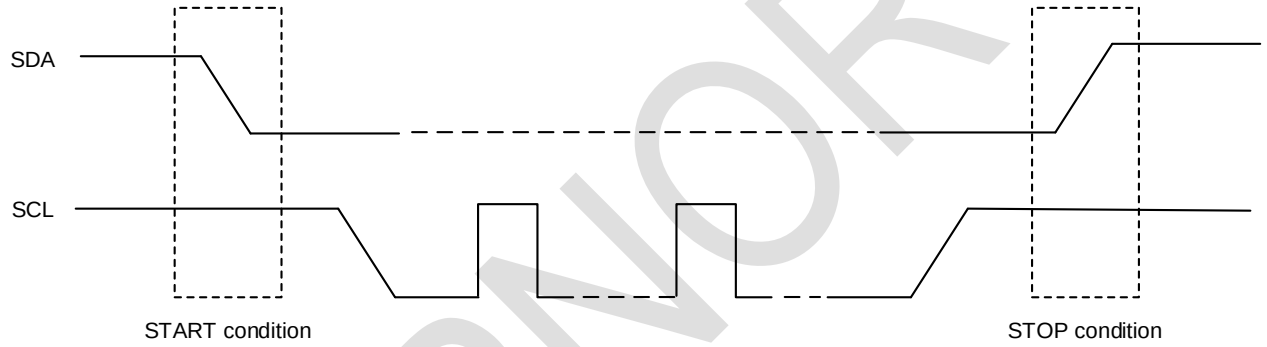
12.1 Command and Data Transfer Method

This Device is transfer data by 2-line serial interface.

When input command or data by 2-line serial interface, it must be generated the state of "START condition" and "STOP condition".

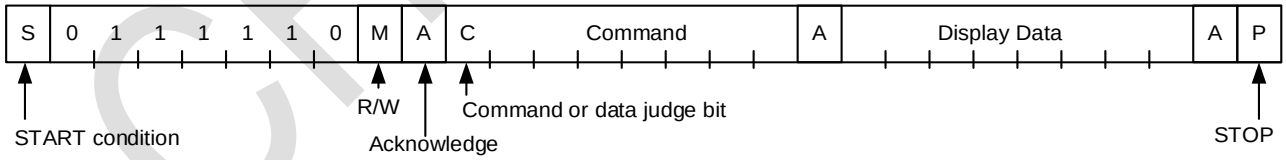
When set SDA "H"→"L" in SCL="H", it become "START condition".

When set SDA "L"→"H" in SCL="H", it become "STOP condition"



START condition and STOP condition.

1. Generate "START condition".
2. Issue Slave address 0x7C.
3. Transfer command.
4. Transfer display data.
5. Generate "STOP condition"



Issue the Slave Address ("01111100" for Write Mode or "01111101" for Read Mode) after the "START condition" is generated. Command input follows after the Slave Address. The least significant bit (LSB) of the Slave Address determines if the operation to be done is Write or Read operation.

The MSB (command or data judgment bit) defines if the succeeding byte is a command or data.

When "command or data judgment bit" ='1', the next byte is a command.

When "command or data judgment bit" ='0', the next byte is display data.

Slave address	1 Command	1 Command	1 Command	0 Command	Display Data

Once it enters display data transfer condition, it cannot input any command.

To input command again, please generate the “START condition” again.

If “START condition” or “STOP condition” is inputted in the middle of command transmission, the command will be cancelled. If the Slave address is continuously inputted following “START condition”, it will be in command input condition.

Please input “Slave Address” in the first data transmission after “START condition”.

When Slave Address cannot be recognized in the first data transmission, Acknowledge does not return and the next transmission will be invalid. When data transmission is in invalid status and the “START condition” is transmitted again, it will return to valid status.

Note: Please confirm that MPU Interface characteristic of Input rise/fall time and setup/hold time in transferring command and data meet the AC specifications. Refer to “MPU Interface Characteristics”.

12.2 Write Display Data and Transfer Method

Set R/W bit to ‘0’ to come into write mode.

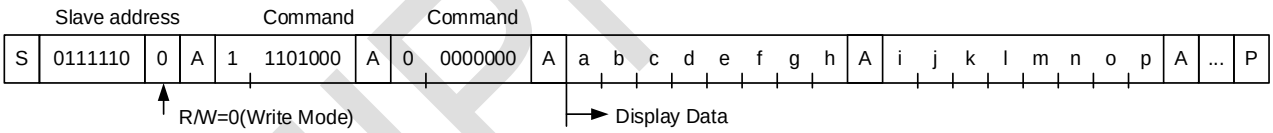
This device has Display Data RAM (DDRAM) of 48×4=192bit.

DDRAM address

BIT	00h	01h	02h	03h	04h	05h	06h	07h	……	2Dh	2Eh	2Fh	
0	a	e	i	m									COM0
1	b	f	j	n									COM1
2	c	g	k	o									COM2
3	d	h	l	p									COM3
	SEG0	SEG1	SEG2	SEG3	SEG4	SEG5	SEG6	SEG7	……	SEG45	SEG46	SEG47	

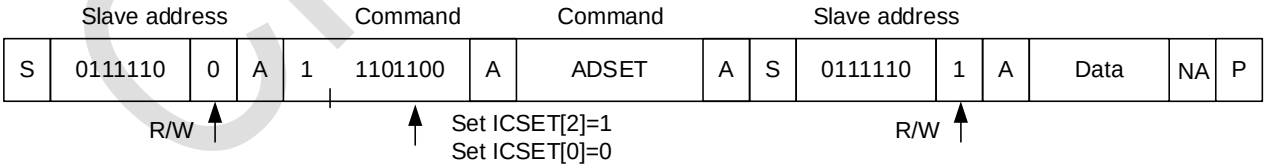
8bit data will be stored in DDRAM. The address to be written is the address specified by Address set command (ADSET), and the address is automatically incremented in every 4bit data.

Data can be continuously written in DDRAM by transmitting Data continuously.



12.3 Read Command Register and Transfer Method

The command registers can be read during read mode. The sequence for the command registers reading is shown below and is similar to the display data read sequence.

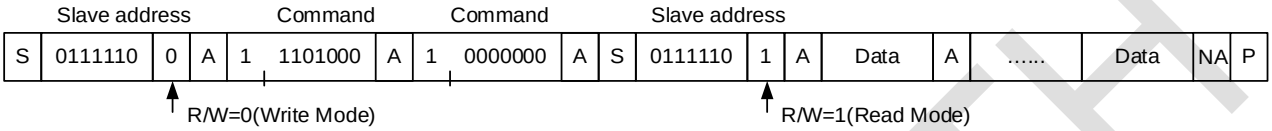


The command register addresses are described below. The following register settings can be read in this mode.

Register	D7	D6	D5	D4	D3	D2	D1	D0	Address
REG1	/	/	/	/	RST	BF[2:0]			30h
REG2	FR[1:0]		SR[1:0]		LF	EN	AON	AOFF	31h
REG3	/	/	/	ULP	EV[3:0]				32h

12.4 Read Display Data and Transfer Method

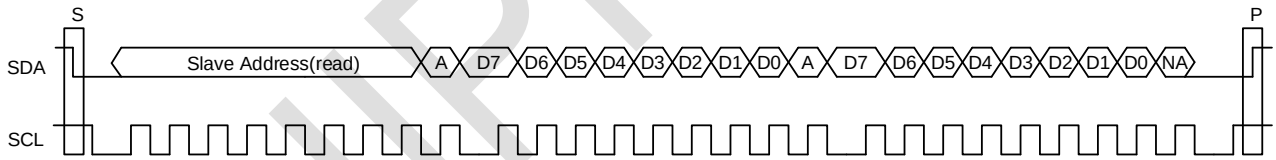
The read mode sequence is shown below.



During read mode, the display data can be read from the DDRAM through the SDA line. The data is outputted serially with SCL input. A write sequence is done first to identify the DDRAM address to be accessed. Then a “START condition” is transmitted again before entering the actual reading of DDRAM data and the Slave Address follows. The display data is outputted continuously afterwards. If no DDRAM address was specified right before the DDRAM read, the output during read mode will be from the current DDRAM address.

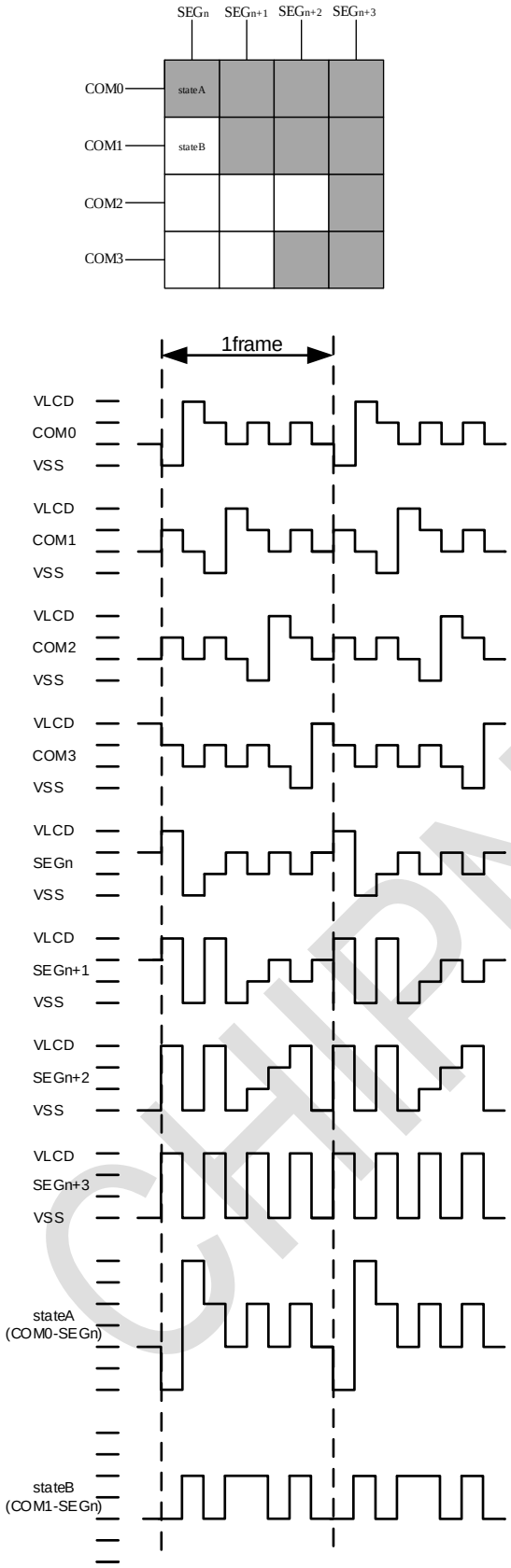
The DDRAM address will increment after every 8-bits of output data. An Acknowledge after every 8-bit of data outputted should be received from the master receiver. This will signal the device that it should continue to output the display data and increment the address. When Non-Acknowledge is received, the device will release the SDA line and the master can then transmit the “STOP condition”. The read mode will be finished once the “STOP condition” is received.

An example of the display data read sequence is shown below.

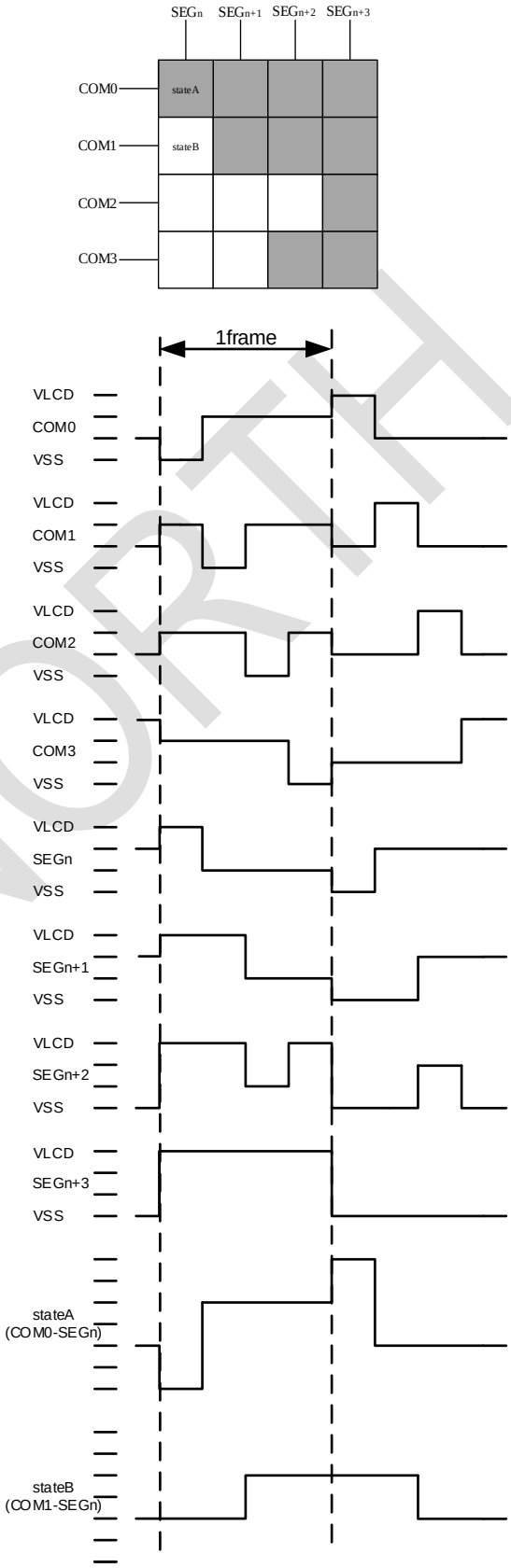


12.5 LCD Driving Waveform

Line Inversion Mode



Frame Inversion Mode



13 Important Statement

Chipnorth Electronic Technology (Nanjing) Co., Ltd. and its subsidiaries reserve the right to make modifications, improvements, corrections, or other changes to this document and to any of the products described herein at any time without notice. Chipnorth Electronic Technology (Nanjing) Co., Ltd. disclaims any liability arising out of the use of this document or any of the products described herein; Chipnorth Electronic Technology (Nanjing) Co., Ltd. does not transfer any license to its patents or trademarks or other rights. Any customer or user using this document or any of the products described herein assumes all risk and agrees to hold harmless Chipnorth Electronic Technology (Nanjing) Co., Ltd. and all companies whose products are displayed on Chipnorth Electronic Technology (Nanjing) Co., Ltd.

Chipnorth Electronic Technology (Nanjing) Co., Ltd. makes no warranty and assumes no responsibility for any products purchased through unauthorized sales channels. In the event that a customer purchases or uses a product from Chipnorth Electronic Technology (Nanjing) Co., Ltd. for any unintended or unauthorized use, the customer shall indemnify and hold harmless Chipnorth Electronic Technology (Nanjing) Co., Ltd. and its representatives from and against all claims, damages, and attorney's fees arising from any personal injury or death, directly or indirectly, arising out of or in connection with such purchase or use.